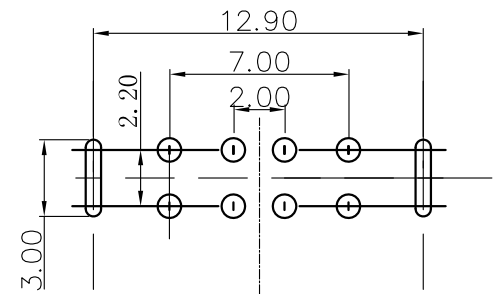
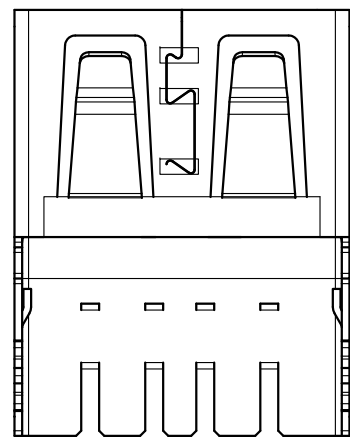
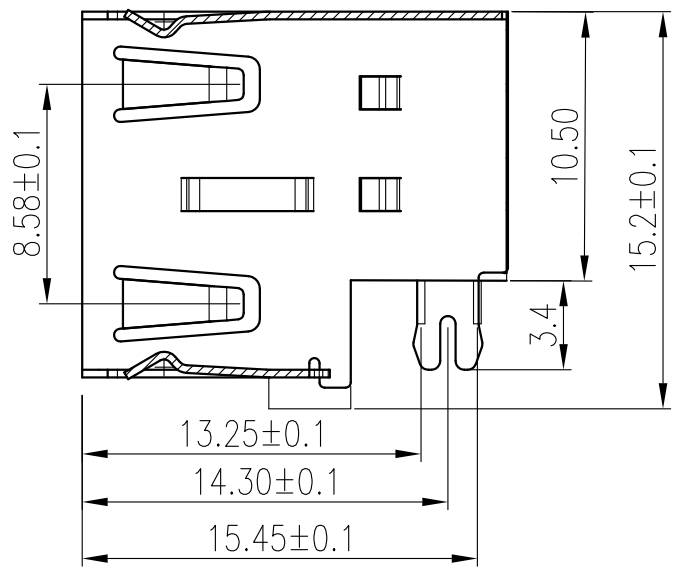
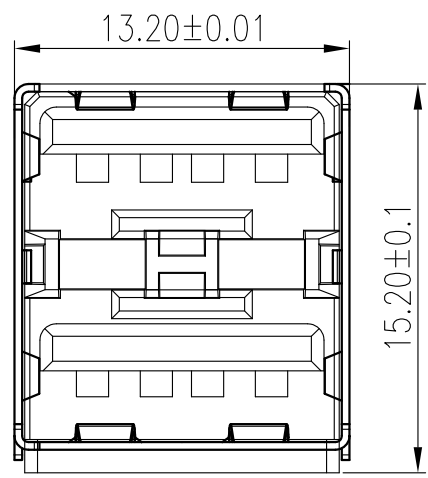


REV.	ECN.NO.	APPD.
A	EXXXXXXXXXXX	chenyiting



NOTES:

- 1.MATERIAL:
  - 1.1 Housing:thermoplastic plastics
  - 1.2 terminals:Copper Alloy  
Gold plated in contact area:  
Tin plated in termination  
Nickel Plated overall
  - 1.3 Shell:Steel&Copper Alloy  
Nickel Plated overall
- 2.ELECTRICAL CHARACTERISTICS:
  - 2.1 Rating Current :1.5 Ampere
  - 2.2 Rating Voltage :30 V Max
  - 2.3 Contact Resistance:30 Milli ohms
  - 2.4 Insulation Resistance:1000 Mega ohms Min.
- 3.MECHANICAL CHARACTERISTICS:
  - 3.1 Connector Mating force: 35N MAX(3.57Kgf)
  - 3.2 Connector Unmating force:10N min(1.02Kgf)
  - 3.3 Durability:1500Cycles.
- 4.ENVIRONMENT CHARACTERISTICS:
  - 4.1 Operating temperature:-0°C to +50°C
  - 4.2 Storage temperature:-20°C to +60°C

U221-J731-G22017

- 1:铁壳镀镍
- 1:吸塑盒
- G:半金G/Fu
- 2:PBT
- 2:白色

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>FLW</b> 深圳市华联威电子科技有限公司				
.XXX ±0.10		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.				
.XX ±0.20						
.X ±0.30						
APPROVED		PART NAME:	AF2.0 双层90度沉板10.5无卷边			
CHECKED		PART No:	U221-J731-G22017			C
DRAWN	chenyiting	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2022.06.02		mm	1:1	1 OF 1	A